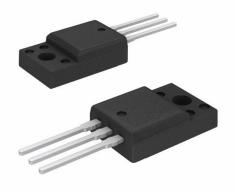


# FDPF51N25 Datasheet

www.digi-electronics.com



DiGi Electronics Part Number

Manufacturer onse

Manufacturer Product Number

Description

**Detailed Description** 

onsemi

FDPF51N25-DG

FDPF51N25

MOSFET N-CH 250V 51A TO220F

N-Channel 250 V 51A (Tc) 38W (Tc) Through Hole T O-220F-3

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# Purchase and inquiry

Manufacturer Product Number:	Manufacturer:
FDPF51N25	onsemi
Series:	Product Status:
UniFET™	Active
FET Type:	Technology:
N-Channel	MOSFET (Metal Oxide)
Drain to Source Voltage (Vdss):	Current - Continuous Drain (Id) @ 25°C:
250 V	51А (Тс)
Drive Voltage (Max Rds On, Min Rds On):	Rds On (Max) @ ld, Vgs:
10V	60mOhm @ 25.5A, 10V
Vgs(th) (Max) @ ld:	Gate Charge (Qg) (Max) @ Vgs:
5V @ 250μΑ	70 nC @ 10 V
Vgs (Max):	Input Capacitance (Ciss) (Max) @ Vds:
±30V	3410 pF @ 25 V
FET Feature:	Power Dissipation (Max):
	38W (Tc)
Operating Temperature:	Mounting Type:
-55°C ~ 150°C (TJ)	Through Hole
Supplier Device Package:	Package / Case:
TO-220F-3	TO-220-3 Full Pack
Base Product Number:	
FDPF51	

# **Environmental & Export classification**

RoHS Status:	Moisture Sensitivity Level (MSL):
ROHS3 Compliant	Not Applicable
REACH Status:	ECCN:
REACH Unaffected	EAR99
HTSUS:	
8541.29.0095	

# onsemi

# MOSFET – N-Channel, UNIFET™

## 250 V, 51 A, 60 m $\Omega$

# FDP51N25, FDPF51N25

## Description

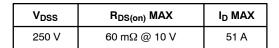
UniFET MOSFET is **onsemi**'s high voltage MOSFET family based on planar stripe and DMOS technology. This MOSFET is tailored to reduce on-state resistance, and to provide better switching performance and higher avalanche energy strength. This device family is suitable for switching power converter applications such as power factor correction (PFC), flat panel display (FPD) TV power, ATX and electronic lamp ballasts.

## Features

- $R_{DS(on)} = 48 \text{ m}\Omega \text{ (Typ.)} @ V_{GS} = 10 \text{ V}, I_D = 25.5 \text{ A}$
- Low Gate Charge (Typ. 55 nC)
- Low C<sub>rss</sub> (Typ. 63 pF)

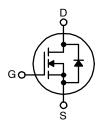
## Applications

- PDP TV
- Lighting
- Uninterruptible Power Supply
- AC-DC Power Supply



#### MARKING DIAGRAM TO-220-3LD FDP CASE 340AT 51N25 AYWWZZ 0 0 TO-220 Fullpack, Ο 3-Lead/ FDPF TO-220F-3SG 51N25 CASE 221AT AYWWZZ FDP51N25, FDPF51N25 = Specific Device Code = Assembly Location А YWW = Date Code (Year & Week) ΖZ = Assembly Lot

## **N-CHANNEL MOSFET**



## **ORDERING INFORMATION**

See detailed ordering and shipping information on page 9 of this data sheet.

Symbol	Parameter		FDP51N25	FDPF51N25	Unit
V <sub>DSS</sub>	Drain-Source Voltage		250		V
Ι <sub>D</sub>	Drain Current	- Continuous (T <sub>C</sub> = 25°C) - Continuous (T <sub>C</sub> = 100°C)	51 30	51* 30*	A A
I <sub>DM</sub>	Drain Current	– Pulsed (Note 1)	204	204*	А
V <sub>GSS</sub>	Gate-Source Voltage		±30		V
E <sub>AS</sub>	Single Pulsed Avalanche Energy (Note 2)		1111		mJ
I <sub>AR</sub>	Avalanche Current (Note 1)		51		А
E <sub>AR</sub>	Repetitive Avalanche Energy (Note 1)		32		mJ
V <sub>ISO</sub>	$_{\rm SO}$ Insulation Withstand Voltage (RMS) from All Three Leads to External Heat Sink (t = 0.3 s; T_C = 25°C)		N/A	2500	V
dv/dt	Peak Diode Recovery dv/dt (Note 3)		4.5		V/ns
P <sub>D</sub>	Power Dissipation $(T_C = 25^{\circ}C)$ – Derate Above $25^{\circ}C$		320 3.7	38 0.3	W W/°C
$T_{J,}T_{STG}$	Operating and Storage Temperature Range		-55 to +150		°C
ΤL	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds		300		°C

#### ABSOLUTE MAXIMUM RATINGS (T<sub>C</sub> = $25^{\circ}$ C unless otherwise noted)

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality Stresses exceeding those listed in the Maximum Hatings table may damage to should not be assumed, damage may occur and reliability may be affected. \*Drain current limited by maximum junction temperature. 1. Repetitive rating: pulse-width limited by maximum junction temperature. 2. L = 0.68 mH, I<sub>AS</sub> = 51 A, V<sub>DD</sub> = 50 V, R<sub>G</sub> = 25  $\Omega$ , starting T<sub>J</sub> = 25°C. 3. I<sub>SD</sub> ≤ 51 A, di/dt ≤ 200 A/µs, V<sub>DD</sub> ≤ BV<sub>DSS</sub>, starting T<sub>J</sub> = 25°C.

#### **THERMAL CHARACTERISTICS**

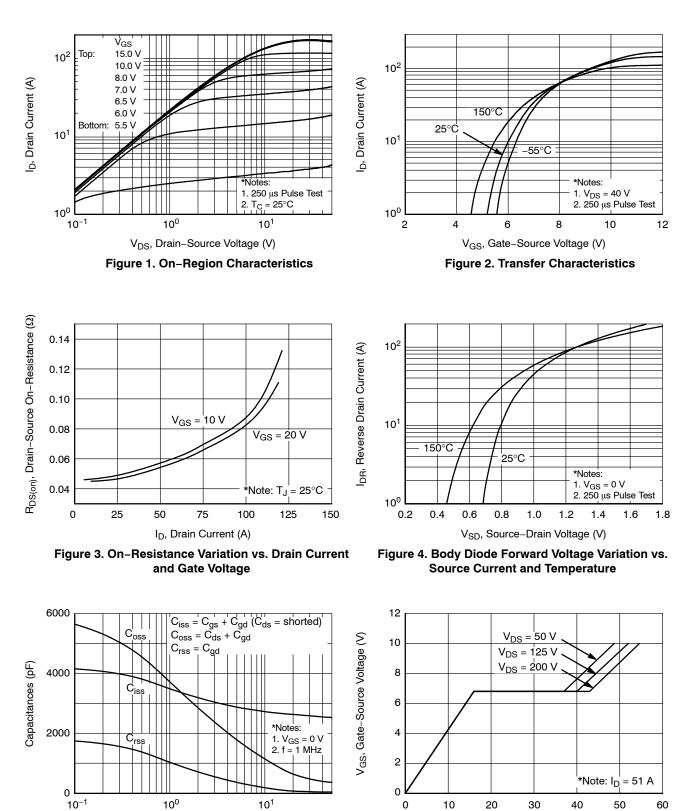
Symbol	Parameter	FDP51N25	FDPF51N25	Unit
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case, Max.	0.39	3.3	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient, Max.	62.5	62.5	°C/W

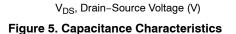
## ELECTRICAL CHARACTERISTICS (T<sub>C</sub> = 25°C unless otherwise noted)

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
OFF CHAR	ACTERISTICS	·				
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	$V_{GS}$ = 0 V, $I_D$ = 250 $\mu A,~T_J$ = 25°C	250	-	_	V
$\frac{\Delta \text{BV}_{\text{DSS}}}{/\Delta\text{T}_{\text{J}}}$	Breakdown Voltage Temperature Coefficient	$I_D$ = 250 µA, Referenced to 25°C	_	0.25	-	V/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{DS} = 250 \text{ V}, V_{GS} = 0 \text{ V}$ $V_{DS} = 200 \text{ V}, T_C = 125^{\circ}\text{C}$	-		1 10	μΑ μΑ
I <sub>GSSF</sub>	Gate-Body Leakage Current, Forward	$V_{GS}$ = 30 V, $V_{DS}$ = 0 V	-	-	100	nA
I <sub>GSSR</sub>	Gate-Body Leakage Current, Reverse	$V_{GS}$ = -30 V, $V_{DS}$ = 0V	-	-	-100	nA
ON CHARA	ACTERISTICS					
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{DS}=V_{GS},I_{D}=250\;\mu A$	3.0	-	5.0	V
R <sub>DS(on)</sub>	Static Drain-Source On-Resistance	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 25.5 A	-	0.048	0.060	Ω
9FS	Forward Transconductance	V <sub>DS</sub> = 40 V, I <sub>D</sub> = 25.5 A	-	43	-	S
DYNAMIC	CHARACTERISTICS					
C <sub>iss</sub>	Input Capacitance	$V_{DS}$ = 25 V, $V_{GS}$ = 0 V, f = 1 MHz	-	2620	3410	pF
Coss	Output Capacitance		-	530	690	pF
C <sub>rss</sub>	Reverse Transfer Capacitance		-	63	90	pF
SWITCHIN	G CHARACTERISTICS					
t <sub>d(on)</sub>	Turn-On Delay Time	$V_{DD} = 125 \text{ V}, \text{ I}_{D} = 51 \text{ A}, \text{ V}_{GS} = 10 \text{ V},$	-	62	135	ns
t <sub>r</sub>	Turn–On Rise Time	R <sub>G</sub> = 25 Ω (Note 4)	-	465	940	ns
t <sub>d(off)</sub>	Turn-Off Delay Time		-	98	205	ns
t <sub>f</sub>	Turn-Off Fall Time		-	130	270	ns
Qg	Total Gate Charge	$V_{DS} = 200 \text{ V}, \text{ I}_{D} = 51 \text{ A}, \text{ V}_{GS} = 10 \text{ V}$	-	55	70	nC
Q <sub>gs</sub>	Gate-Source Charge	(Note 4)	-	16	-	nC
Q <sub>gd</sub>	Gate-Drain Charge		-	27	-	nC
DRAIN-SO	URCE DIODE CHARACTERISTICS AND MAX	IMUM RATINGS				
۱ <sub>S</sub>	Maximum Continuous Drain-Source Diode Fo	rward Current	-	-	51	Α
I <sub>SM</sub>	Maximum Pulsed Drain-Source Diode Forward Current		-	-	204	А
$V_{SD}$	Drain-Source Diode Forward Voltage	V <sub>GS</sub> = 0 V, I <sub>S</sub> = 51 A	-	-	1.4	V
t <sub>rr</sub>	Reverse Recovery Time	$V_{GS} = 0 V, I_S = 51 A,$	-	178	-	ns
Q <sub>rr</sub>	Reverse Recovery Charge	dI <sub>F</sub> /dt =100 Ā/μs	-	4.0	-	μC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 4. Essentially independent of operating temperature typical characteristics.

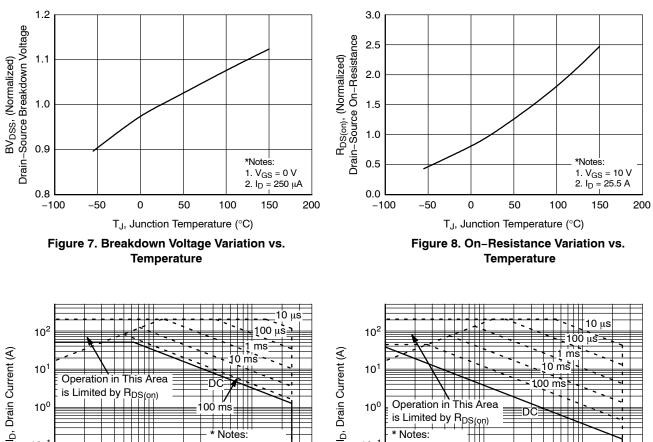
### **TYPICAL PERFORMANCE CHARACTERISTICS**





Q<sub>G</sub>, Total Gate Charge (nC) Figure 6. Gate Charge Characteristics

#### TYPICAL PERFORMANCE CHARACTERISTICS (CONTINUED)



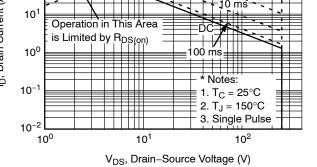
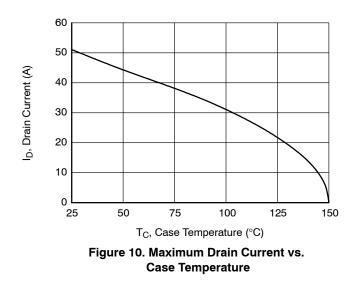
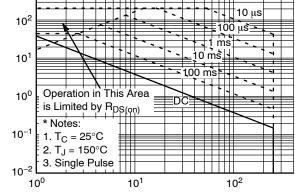


Figure 9–1. Maximum Safe Operating Area for FDP51N25





V<sub>DS</sub>, Drain-Source Voltage (V)

Figure 9-2. Maximum Safe Operating Area for FDPF51N25

TYPICAL PERFORMANCE CHARACTERISTICS (CONTINUED)

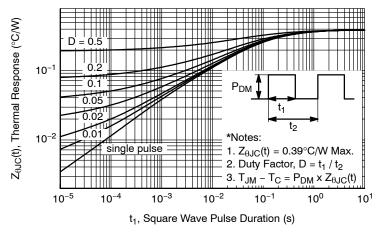


Figure 11–1. Transient Thermal Response Curve for FDP51N25

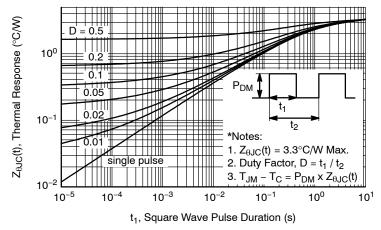


Figure 11–2. Transient Thermal Response Curve for FDPF51N25

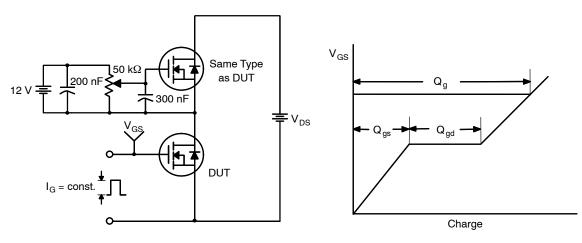


Figure 11. Gate Charge Test Circuit & Waveform

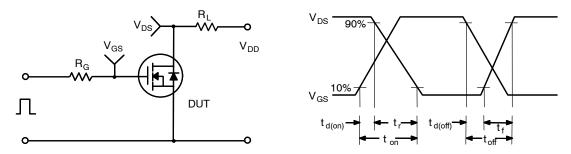


Figure 12. Resistive Switching Test Circuit & Waveforms

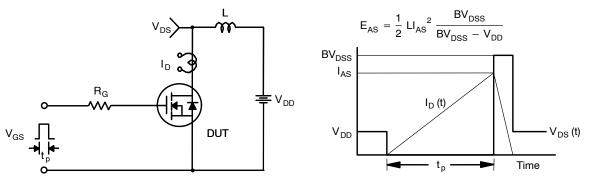
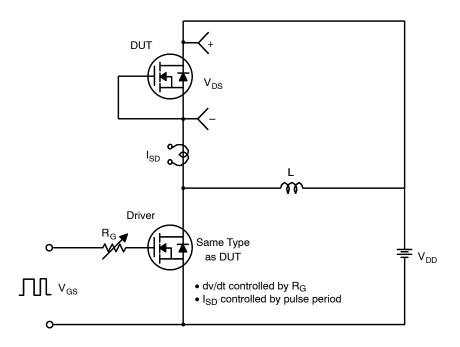
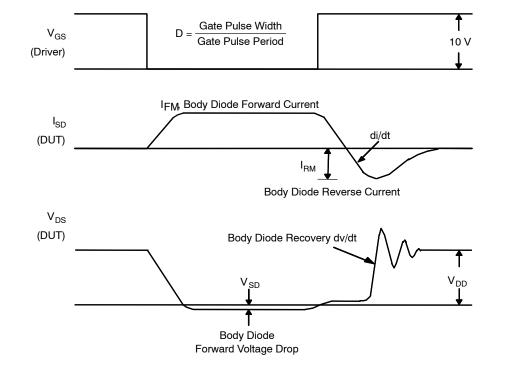


Figure 13. Unclamped Inductive Switching Test Circuit & Waveforms





### PACKAGE MARKING AND ORDERING INFORMATION

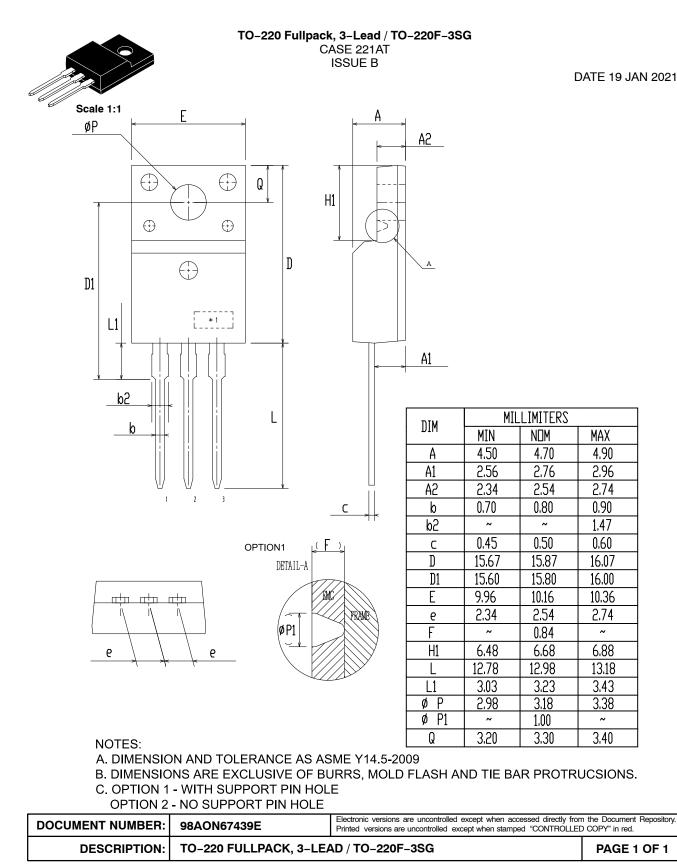
Part Number	Top Mark	Package	Shipping
FDP51N25	FDP51N25	TO-220-3LD CASE 340AT	1000 Units / Tube
FDPF51N25	FDPF51N25	TO-220 Fullpack, 3-Lead / TO-220F-3SG CASE 221AT	1000 Units / Tube

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**MECHANICAL CASE OUTLINE** 

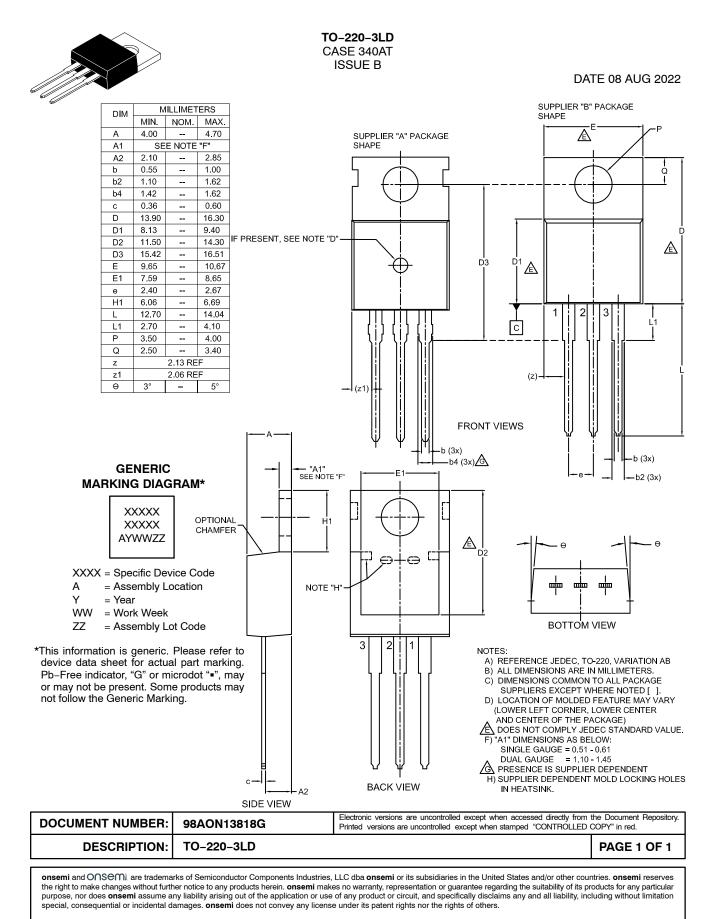
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